Presentation to the

High Performance Embedded Computing Conference 2002:

From PIM to Petaflops Computing

MIND: Scalable Embedded Computing through Advanced Processor in Memory

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and

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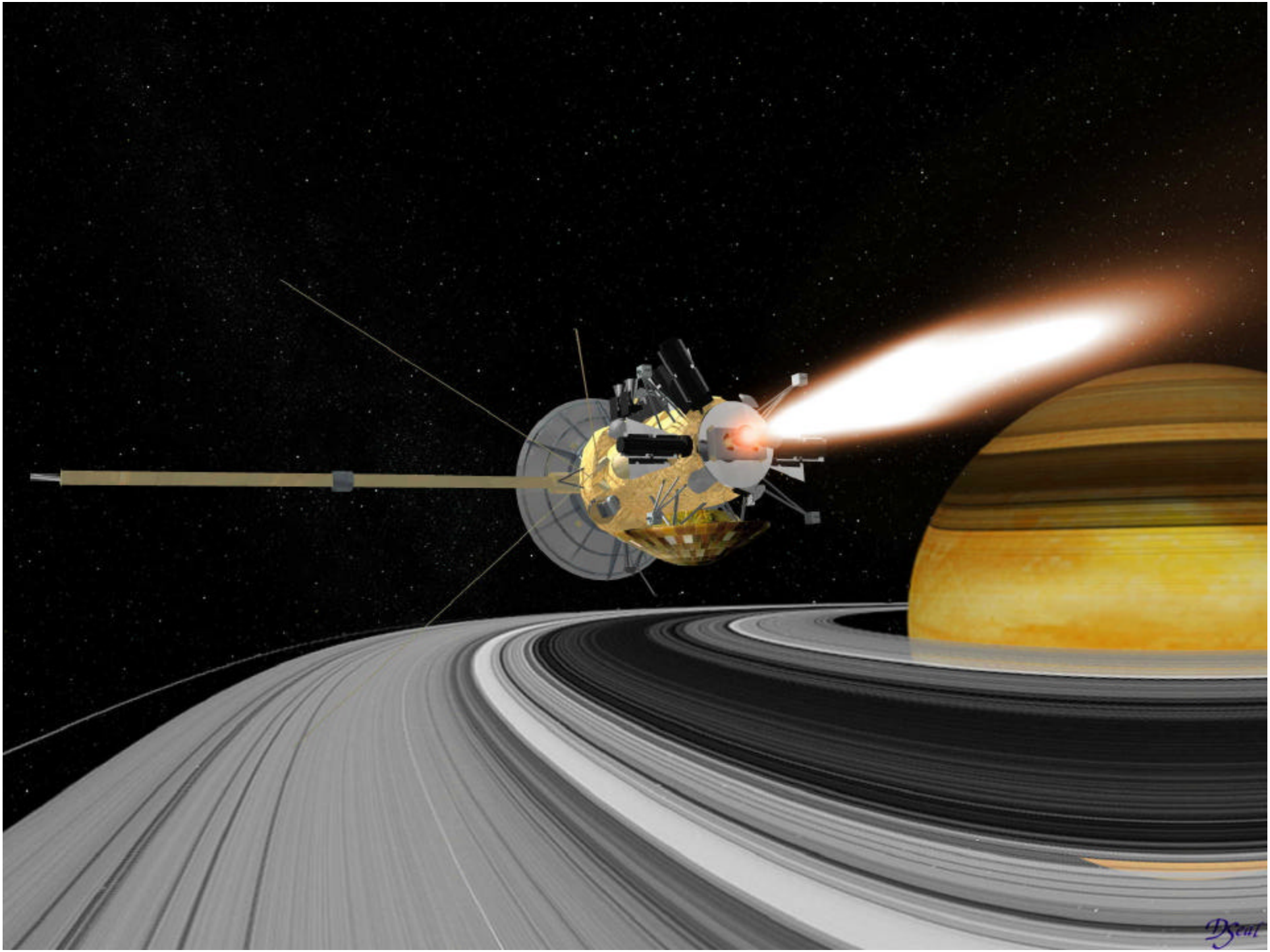
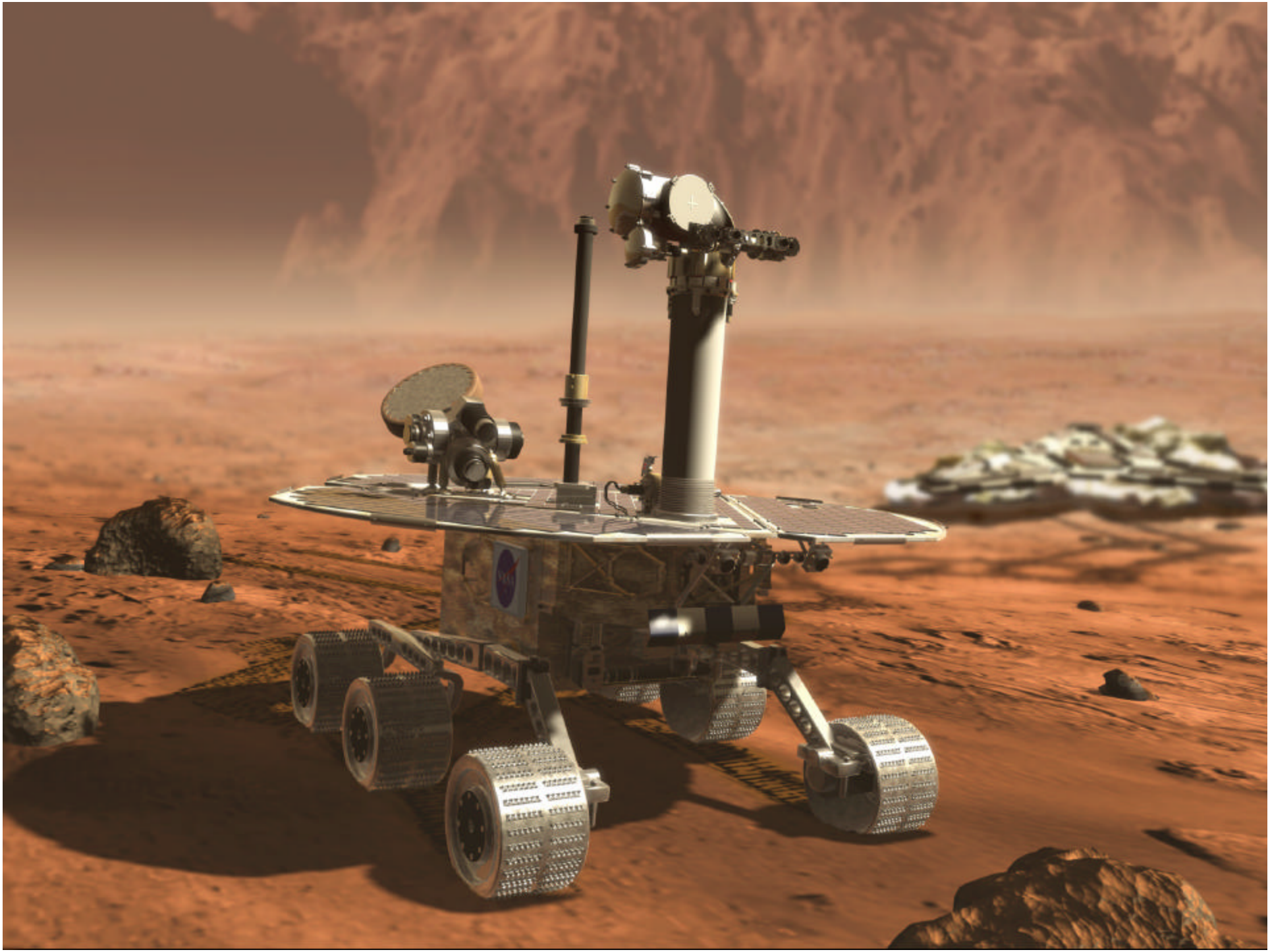
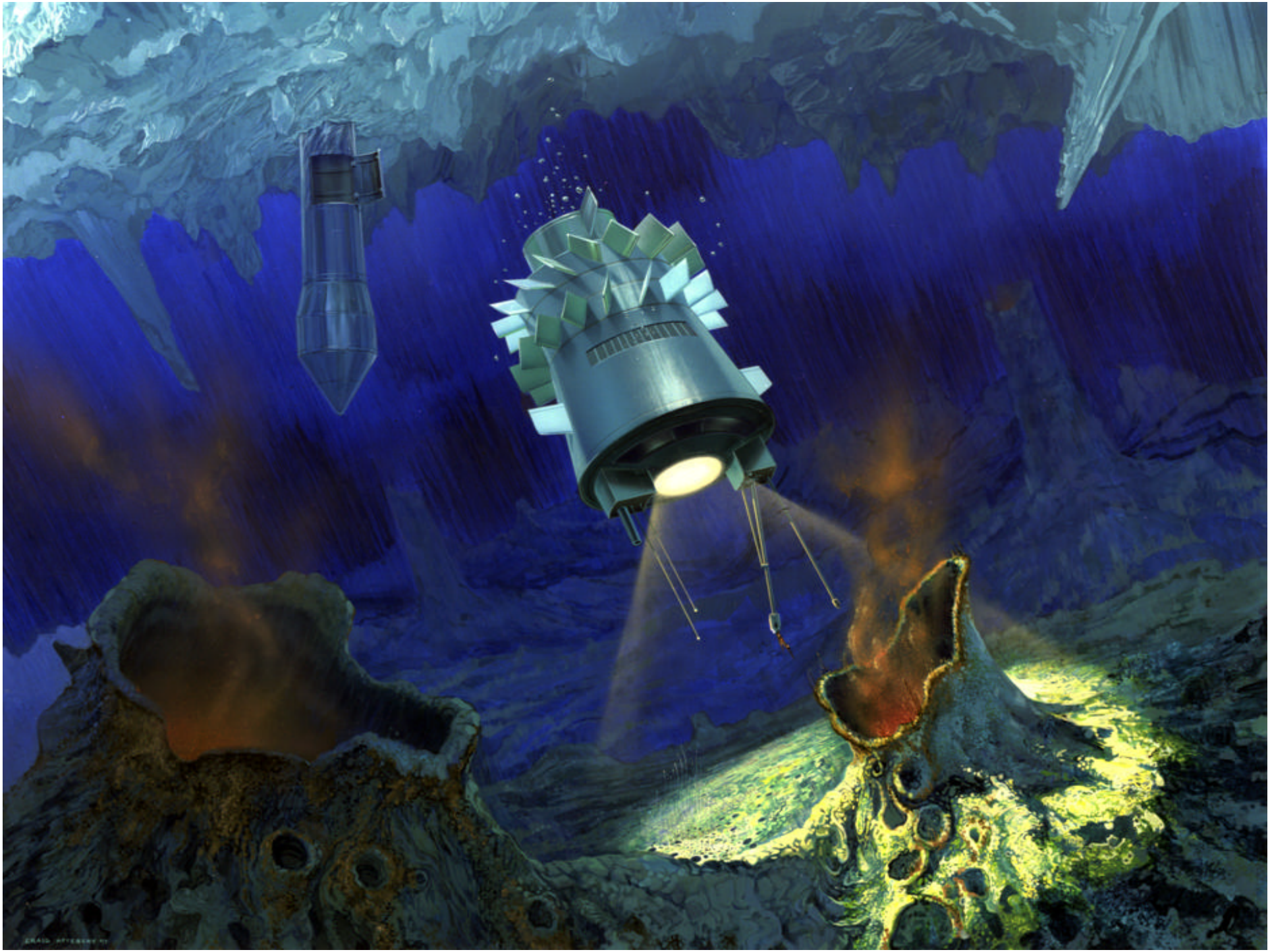






Summary of Mission Driver Factors

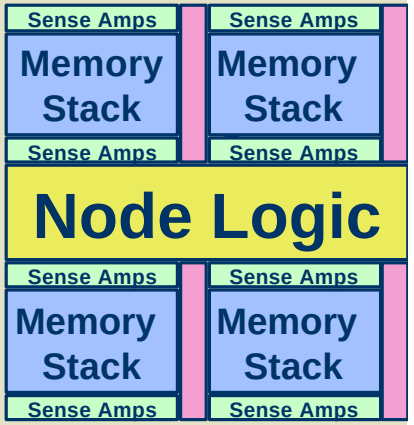
- Speed of light preclude real time manual control
- Mission duration and spacecraft lifetime up to 100 years
- Adaptivity to system and environmental uncertainty through reasoning
- Cost of ground based deep space tracking and high bandwidth downlink
- Weight and cost of space craft high bandwidth downlink
  - Antennas, Transmitter, Power supply
  - Raw power source
  - Maneuver rockets and/or inertial storage, Mid course main engine thrusters
  - Launch vehicle fuel and type
- On-board science computation
- On-board mission planning (long term and real time)
- On-board mission fault detection, diagnostic, and reconfiguration
- Obstructed mission profiles

Goals for a New Generation of Spaceborne Supercomputer

- Performance gain of 100 to 10,000
- Low power, high power efficiency.
- Wide range for active power management.
- Fault tolerance and graceful degradation.
- High scalability to meet widely varying mission profiles.
- Common ISA for software reuse and technology migration.
- Multitasking, real time response.
- Numeric, data oriented, and symbolic computation.

Processor in Memory (PIM)

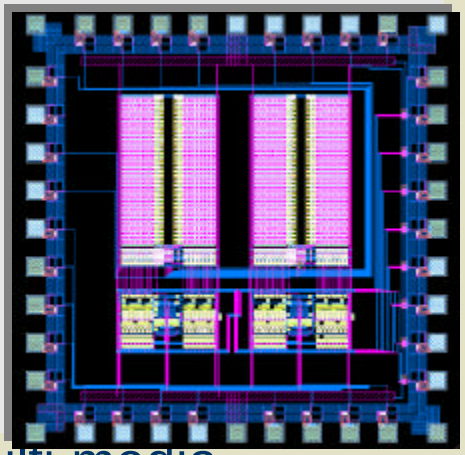
- PIM merges logic with memory
  - Wide ALUs next to the row buffer
  - Optimized for memory throughput, not ALU utilization
- PIM has the potential of riding Moore's law while
  - greatly increasing effective memory bandwidth,
  - providing many more concurrent execution threads,
  - reducing latency,
  - reducing power, and
  - increasing overall system efficiency
- It may also simplify programming and system design

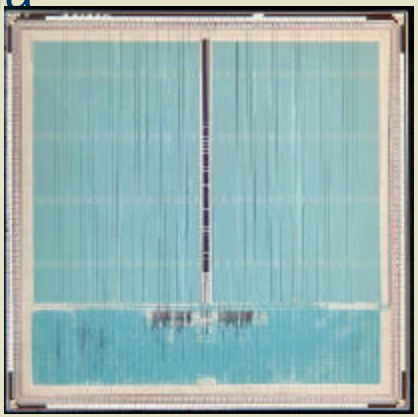


Why is PIM Inevitable?

- Separation between memory and logic artificial
  - von Neumann bottleneck
  - Imposed by technology limitations
  - Not a desirable property of computer architecture
- Technology now brings down barrier
  - We didn't do it because we couldn't do it
  - We can do it so we will do it
- What to do with a billion transistors
  - Complexity can not be extended indefinitely
  - Synthesis of simple elements through replication
  - Means to fault tolerance, lower power
- Normalize memory touch time through scaled bandwidth with capacity
  - Without it, takes ever longer to look at each memory block
- Will be mass market commodity commercial market
  - Drivers outside of HPC thrust
  - Cousin to embedded computing

Current PIM Projects





- IBM Blue Gene
  - Pflops computer for protein folding
- UC Berkeley IRAM
  - Attached to conventional servers for multi-media
- USC ISI DIVA
  - Irregular data structure manipulation
- U of Notre Dame PIM-lite
  - Multithreaded
- Caltech MIND
  - Virtual everything for scalable fault tolerant general purpose

Limitations of Current PIM Architectures

- No global address space
- No virtual to physical address translation
  - DIVA recognizes pointers for irregular data handling
- Do not exploit full potential memory bandwidth
  - Most use full row buffer
  - Blue Gene/Cyclops has 32 nodes
- No memory to memory process invocation
  - PIM-lite & DIVA use *parcels* for method driven computation
- No low overhead context switching
  - BG/C and PIM-lite have some support for multithreading

MIND Architecture

- ***M**emory-**I**ntelligence-and-**N**etworking **D**evices*
- Target systems
  - Homogenous MIND arrays
  - Heterogeneous MIND layer with external high-speed processors
  - Scalable embedded
- Addresses challenges of:
  - global shared memory and virtual paged management
  - irregular data structure handling
  - dynamic adaptive on-chip resource management
  - inter-chip transactions
  - global system locality and latency management
  - power management and system configurability
  - fault tolerance

Attributes of MIND Architecture

- Parcel active message driven computing
  - Decoupled split-transaction execution
  - System wide latency hiding
  - Move work to data instead of data to work
- Multithreaded control
  - Unified dynamic mechanism for resource management
  - Latency hiding
  - Real time response
- Virtual to physical address translation in memory
  - Global distributed shared memory thru distributed directory table
  - Dynamic page migration
  - Wide registers serve as context sensitive TLB
- Graceful degradation for Fault tolerance

MIND Mesh Array

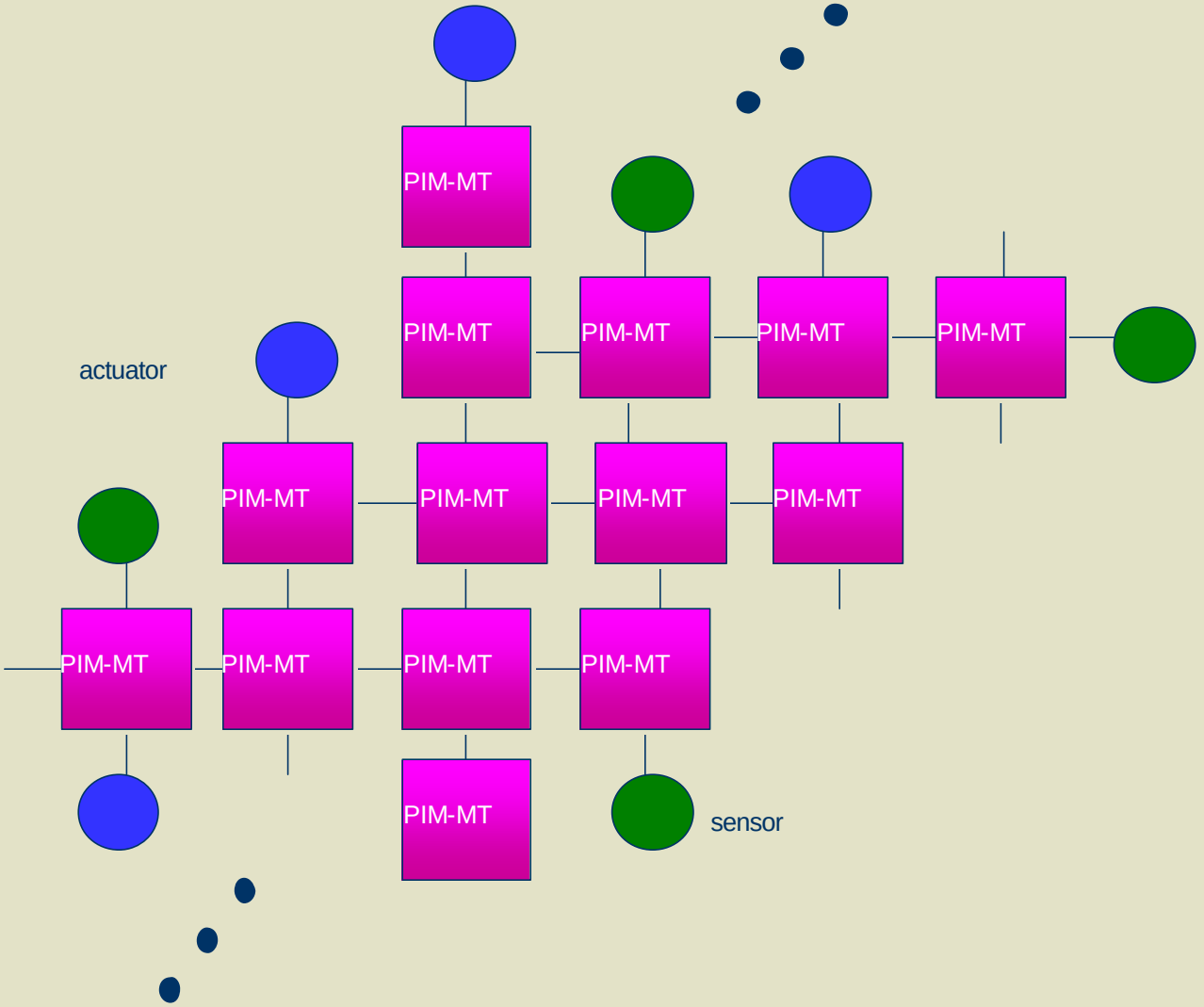
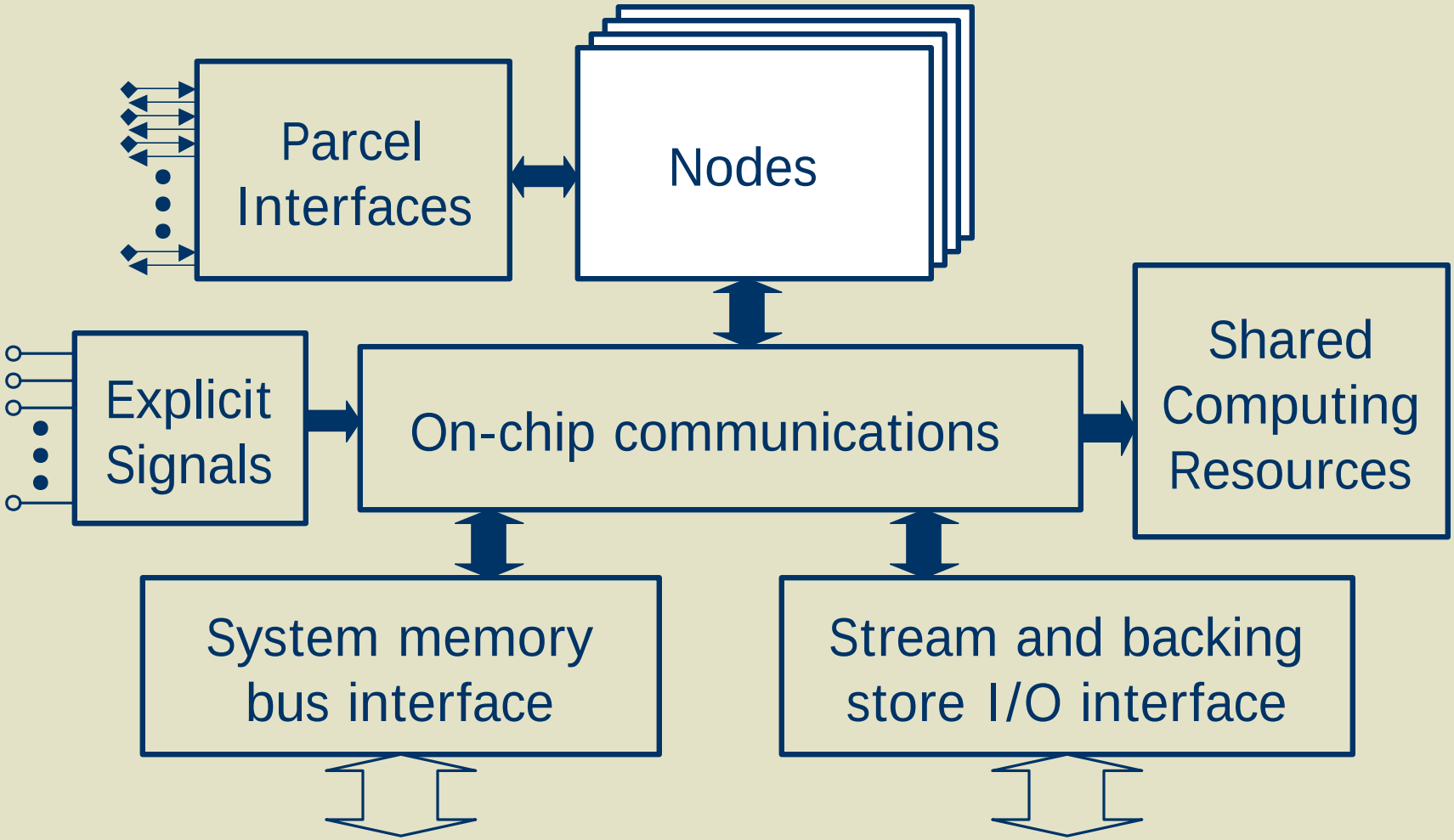
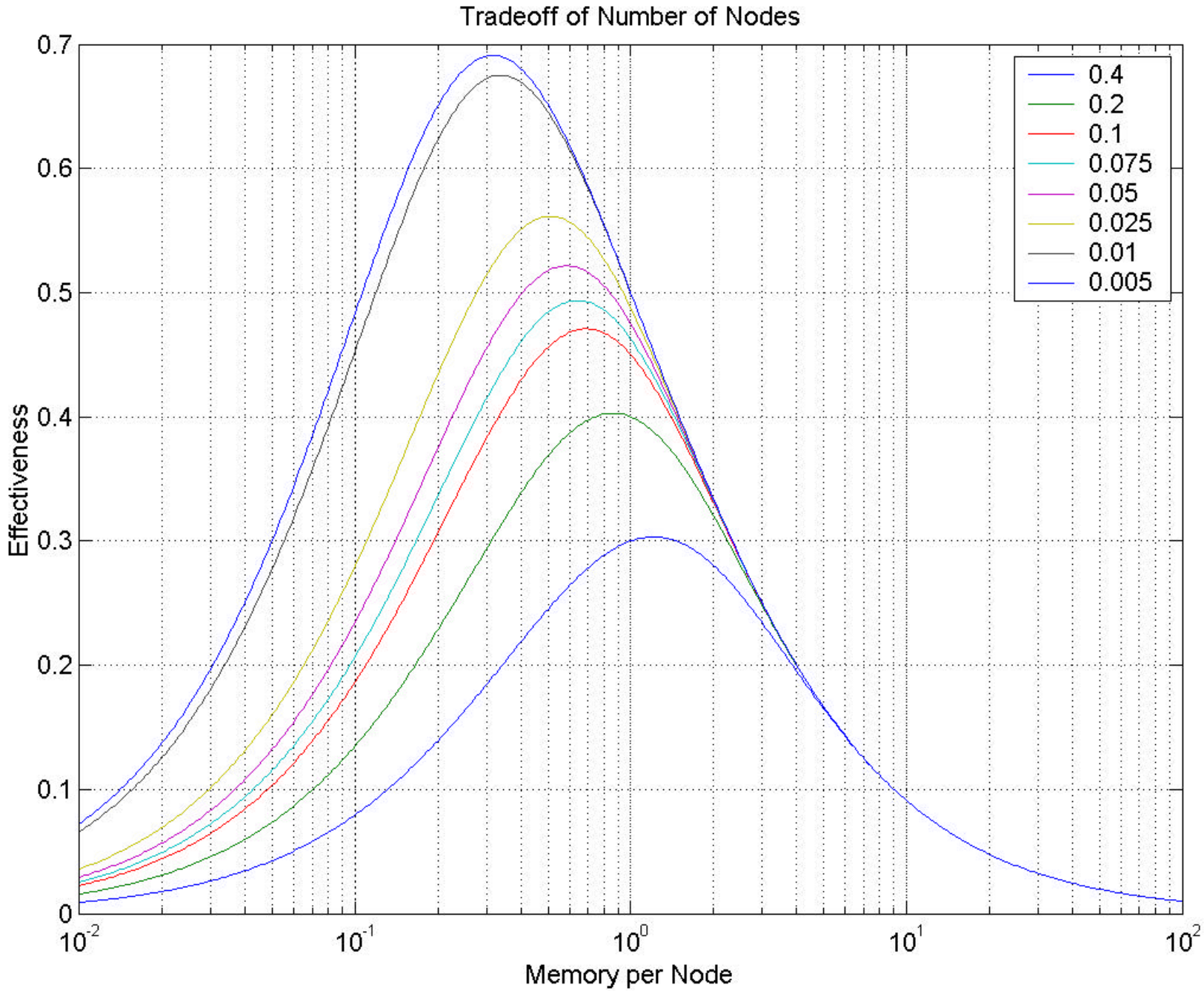
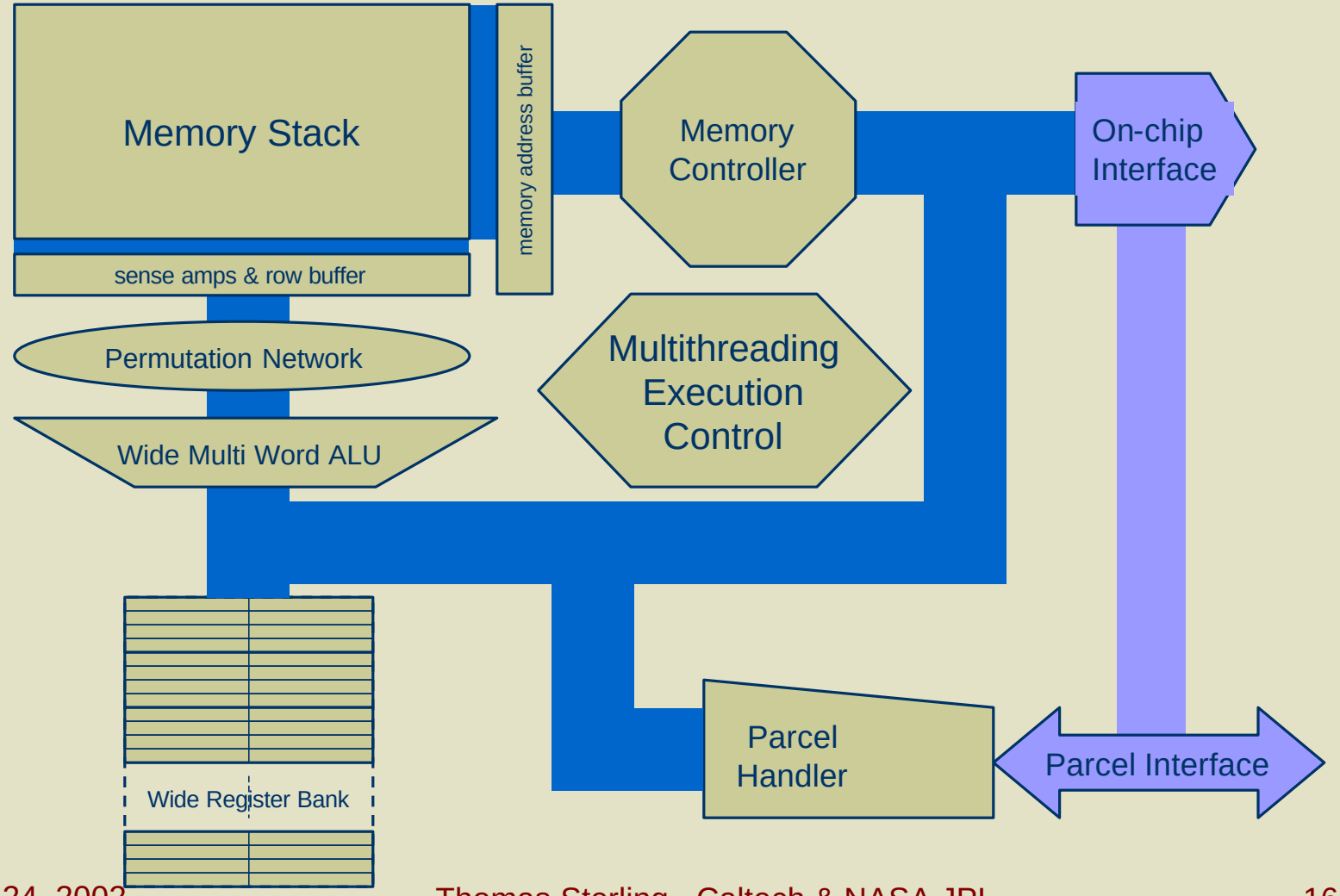


Diagram - MIND Chip Architecture




Tradeoff of Number of Nodes
Effectiveness
Memory per Node
0.7
0.6
0.5
0.4
0.3
0.2
0.1
0
10^{-2}
10^{-1}
10^{0}
10^{1}
10^{2}
0.4
0.2
0.1
0.075
0.05
0.025
0.01
0.005

MIND Node


Memory Stack
memory address buffer
Memory Controller
On-chip Interface
sense amps & row buffer
Permutation Network
Multithreading Execution Control
Wide Multi Word ALU
Wide Register Bank
Parcel Handler
Parcel Interface

Unified Register Set Supports a Diversity of Runtime Mechanisms

- Node status word
- Thread state
- Parcel decoding
- Parcel construction
- Vector register
- Translation Lookaside Buffer
- Instruction cache
- Data cache
- Irregular Data Structure Node (data, pointers, usw.)

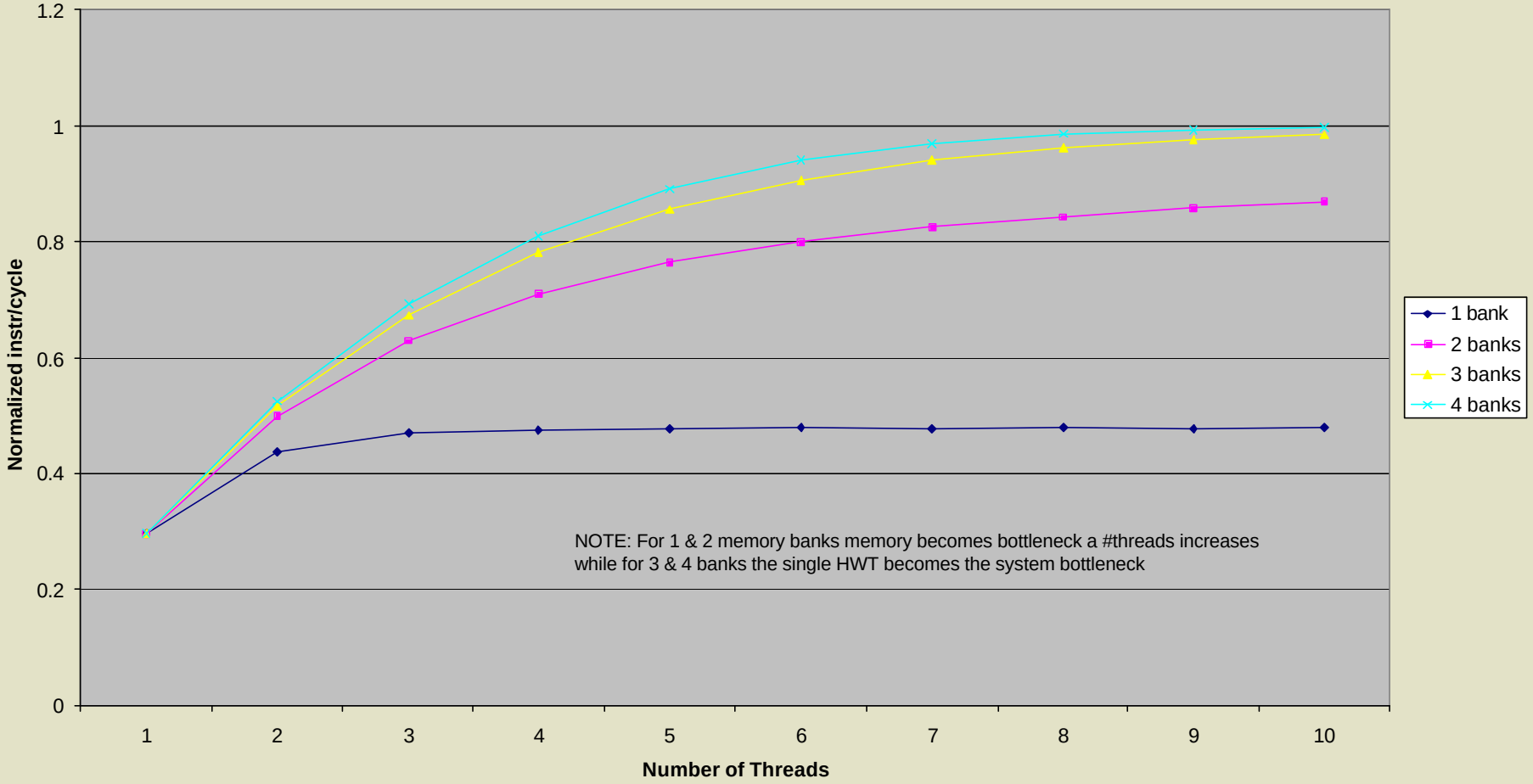
MIND Node Instruction Set

- Basic set of word operations
- Row wide field permutations for reordering and alignment
- Data parallel ops across row-wide register and delimited subfields
- Parallel dual ops with key field and data field for rapid associative searches
- Thread management and control
- Parcel explicit create, send, receive
- Virtual and physical word access; local, on-chip, remote
- Floating point
- Reconfiguration
- Protected supervisor

Multithreading in PIMS

- MIND must respond asynchronously to service requests from multiple sources
- Parcel-driven computing requires rapid response to incident packets
- Hardware supports multitasking for multiple concurrent method instantiations
- High memory bandwidth utilization by overlapping computation with access ops
- Manages shared on-chip resources
- Provides fine-grain context switching
- Latency hiding

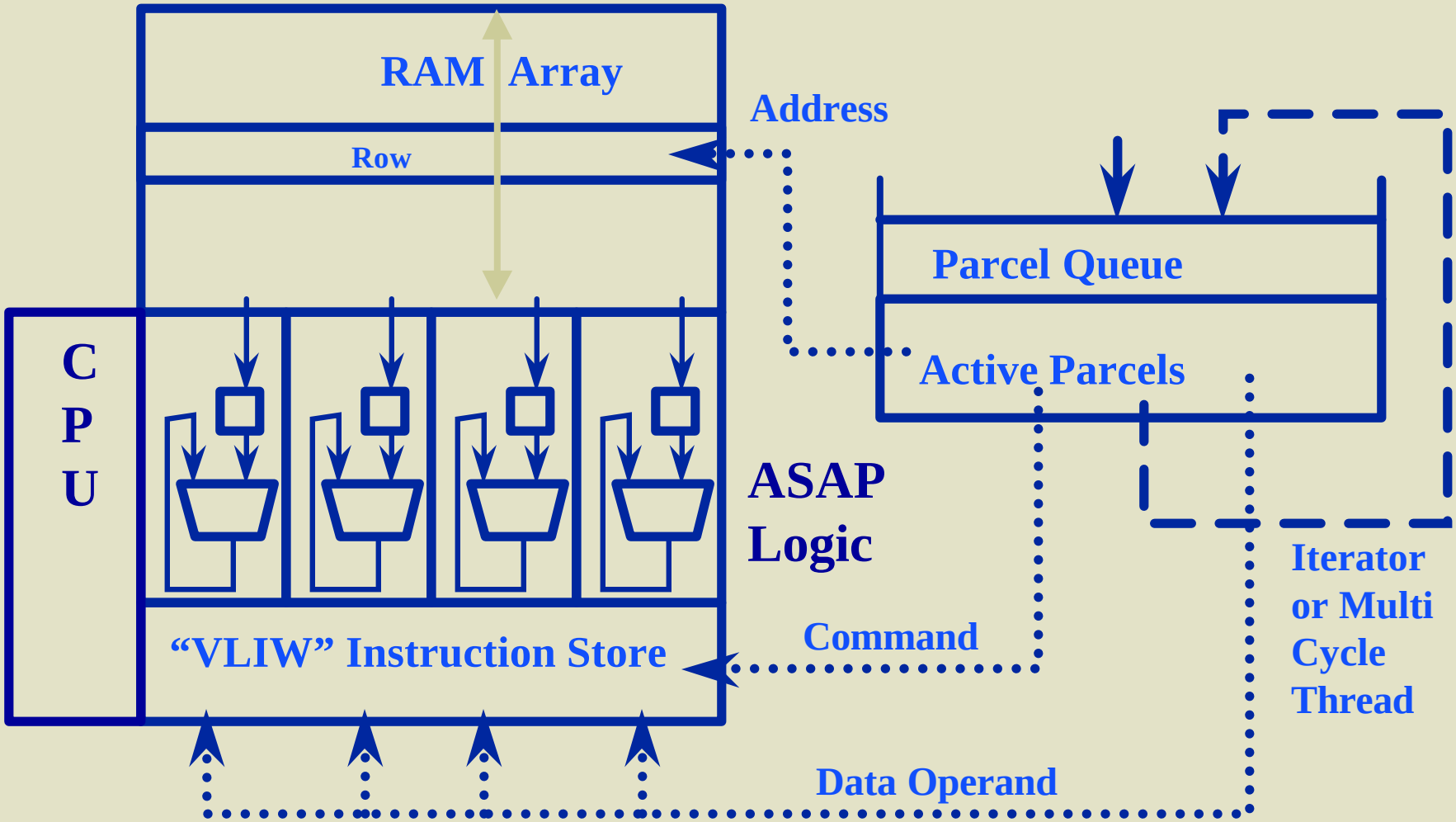
Single HWT: Multiple Memory Banks; MultiThread
probability of reg-to-reg instr fixed at 0.7
probability of data cache hit fixed at 0.9
Memory access fixed at 70 cycles



PIM Parcel Model

- Parcel: logically complete grouping of info sent to a node on a PIM chip
  - by SPELLs, other PIM nodes
- At arrival, triggers local computation:
  - Read from local memory
  - Perform some operation(s)
  - Write back locally (optional)
  - Return value to sender (optional)
  - Initiate additional parcel(s) (optional)

PIM Node Architecture



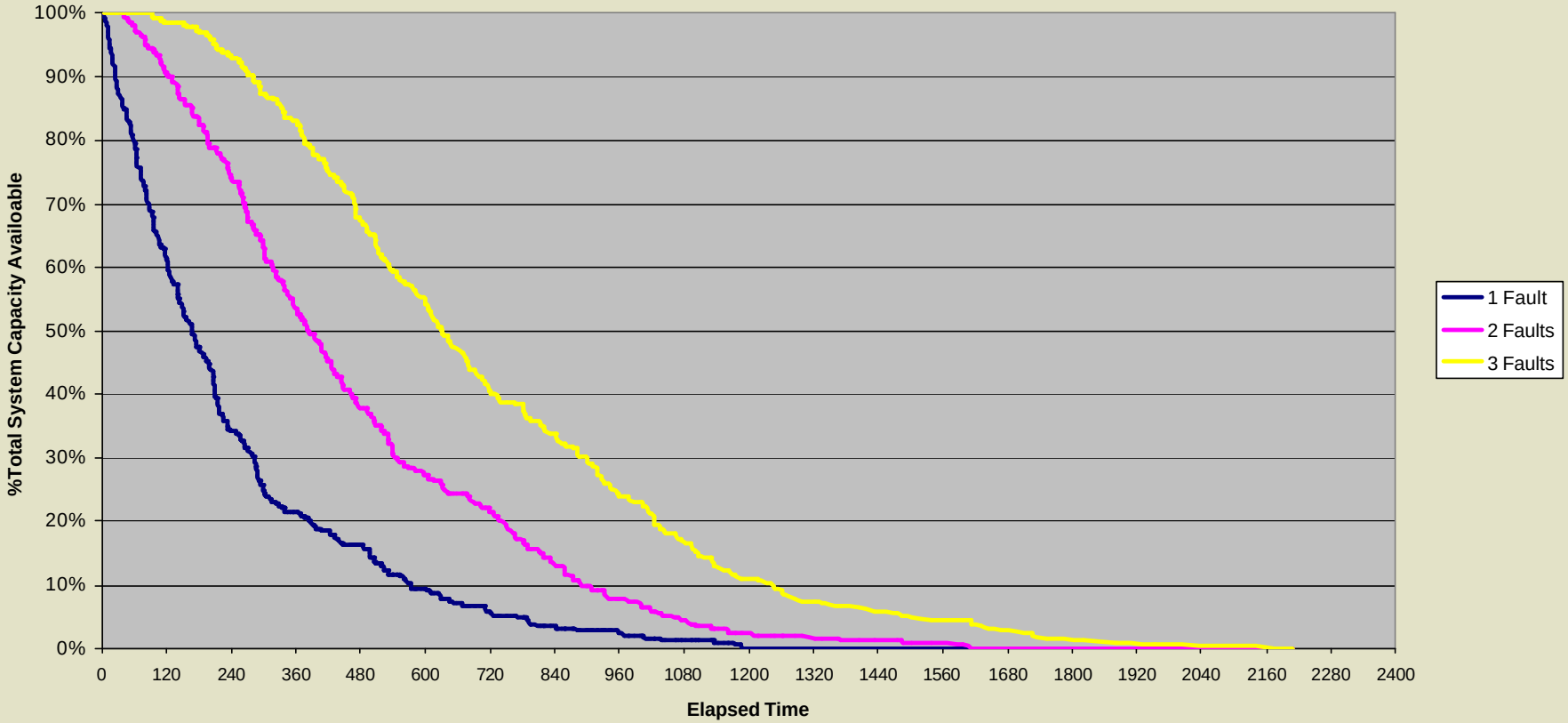
Virtual Page Handling

- Pages preferentially distributed in local groups with associated page entry tables
- Directory table entries located by physical address
- Pages may be randomly distributed within MIND chip or group
- Pages may be randomly distributed requiring second hop from page table location
- Supervisor address space supports local node overhead and service tasks.
- Copying to physical pages, not to virtual
- Demand paging to/from backing store or other MIND chips
- Nodes directly address memory of others on same MIND chip

Fault Tolerance

- Near fine-grain redundancy provides multiple alike resources to perform workload tasks.
- Even single-chip Gilgamesh (for rovers, sensor webs) will incorporate 4-way to 16-way redundancy and graceful degradation.
- Hardware architecture includes fault detection mechanisms.
- Software tags for bit-checking at hardware speeds; includes constant memory scrubbing.
- Monitor threads for background fault detection and diagnosis
- Virtual data and tasks permits rapid reconfiguration without software regeneration or explicit remapping.

System Availability as Function Of Number of Faults Before Node Failure
MTBF = 1 unit Exponential Arrival Rate of Faults
64 Modules 4 Nodes/Module



Real Time Response

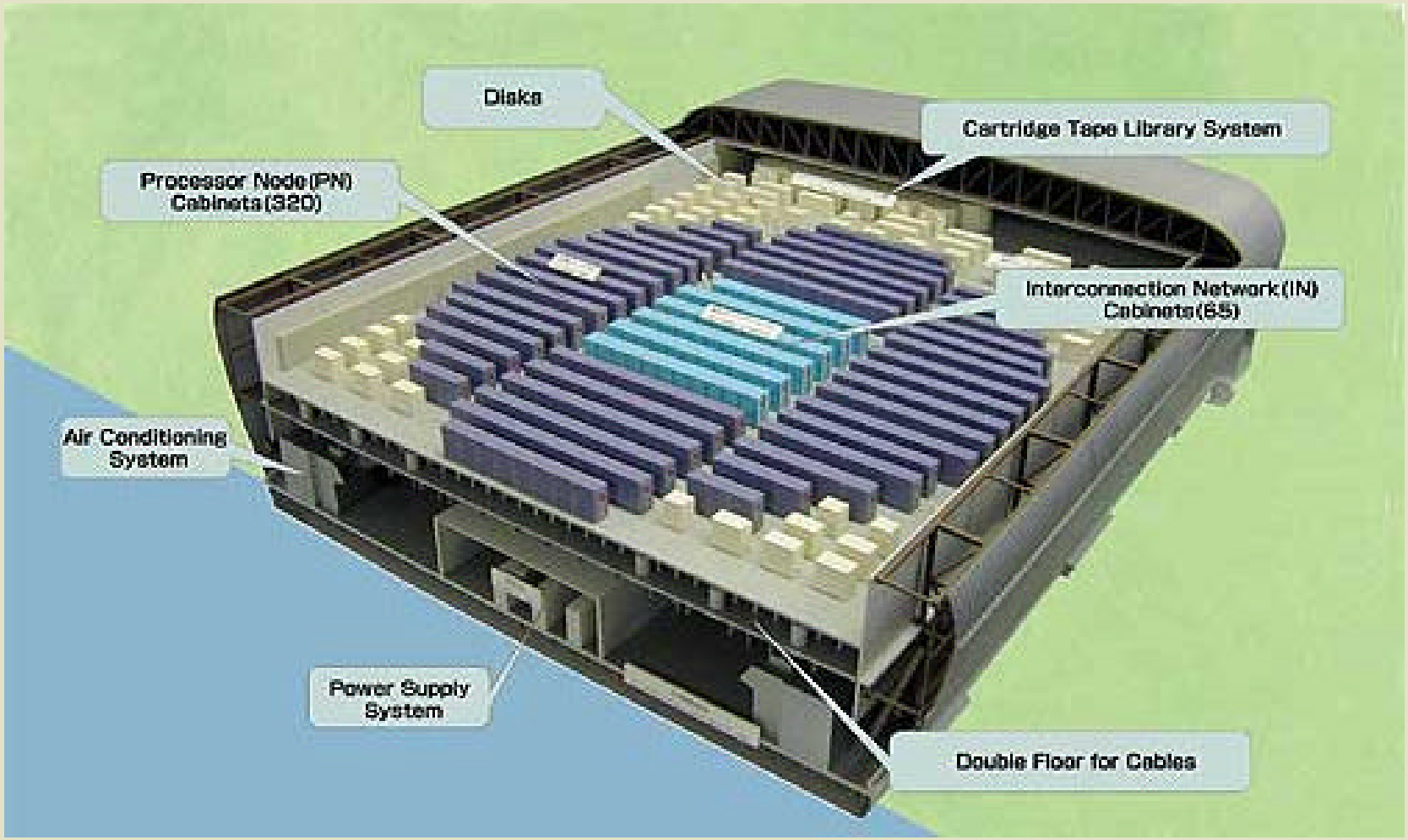
- Multiple nodes permits dedication of a single node to a single real time task
- Threads and pages can be *nailed down* for real time tasks
- Multithreading uses real time priority for guaranteed reaction time
- Preemptive memory access
- Virtual address translation can be buffered in registers as TLB
- Hardwired signal lines from sensors and to actuators

Power Reduction Strategy

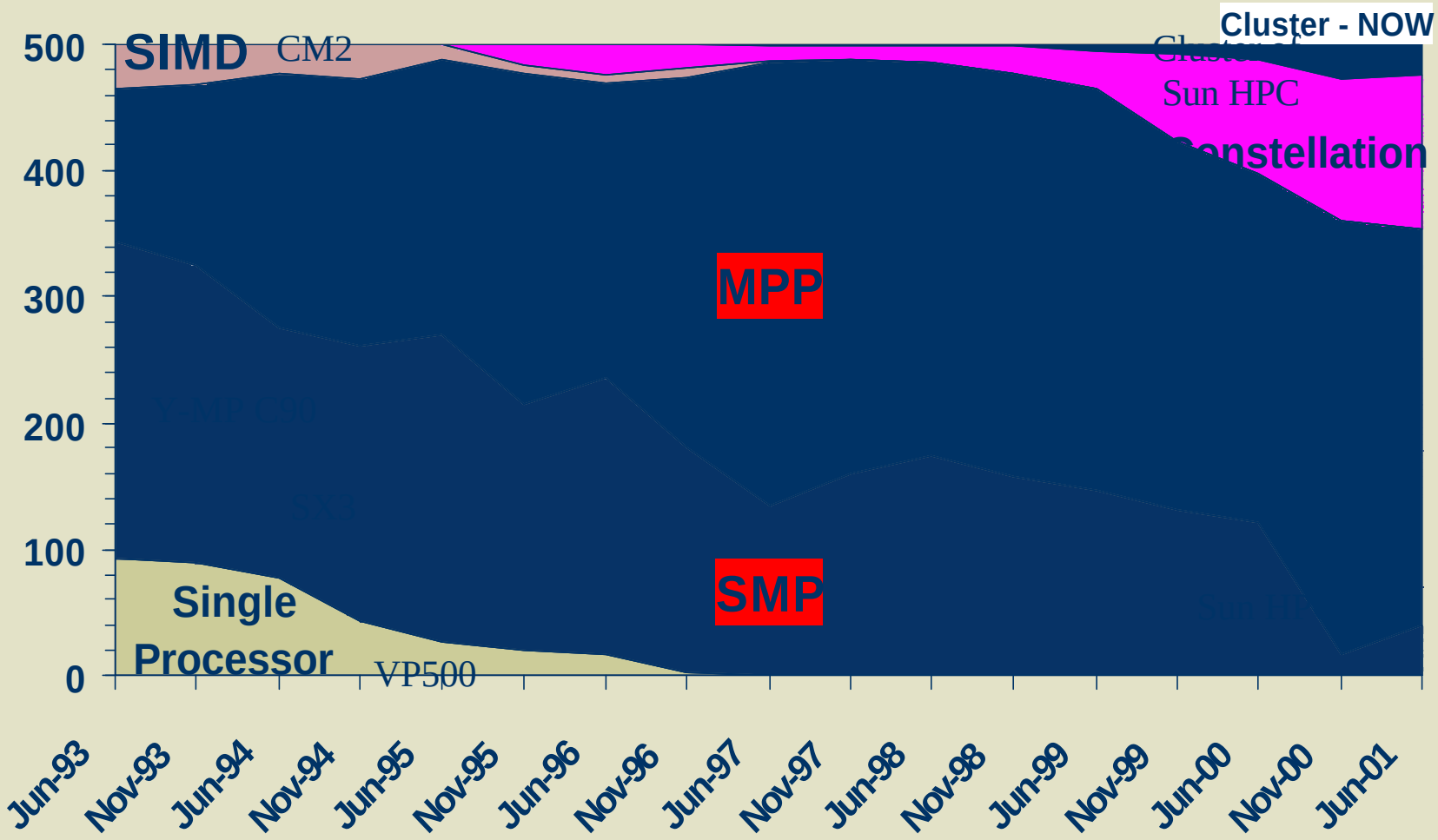
- **Objective**: achieve 10 to 100 reduction in power over conventional systems of comparable performance.
- On-chip data operations avoids external I/O drivers.
- Number of memory block row accesses reduced because all row bits available for processing.
- Simple processor with reduced logic. No branch prediction prediction, speculative execution, complex scoreboarding.
- No caches.
- Power management of separate processor/memory nodes.


PN-07-12/13
PN-08-08/09
PN-09-14/15

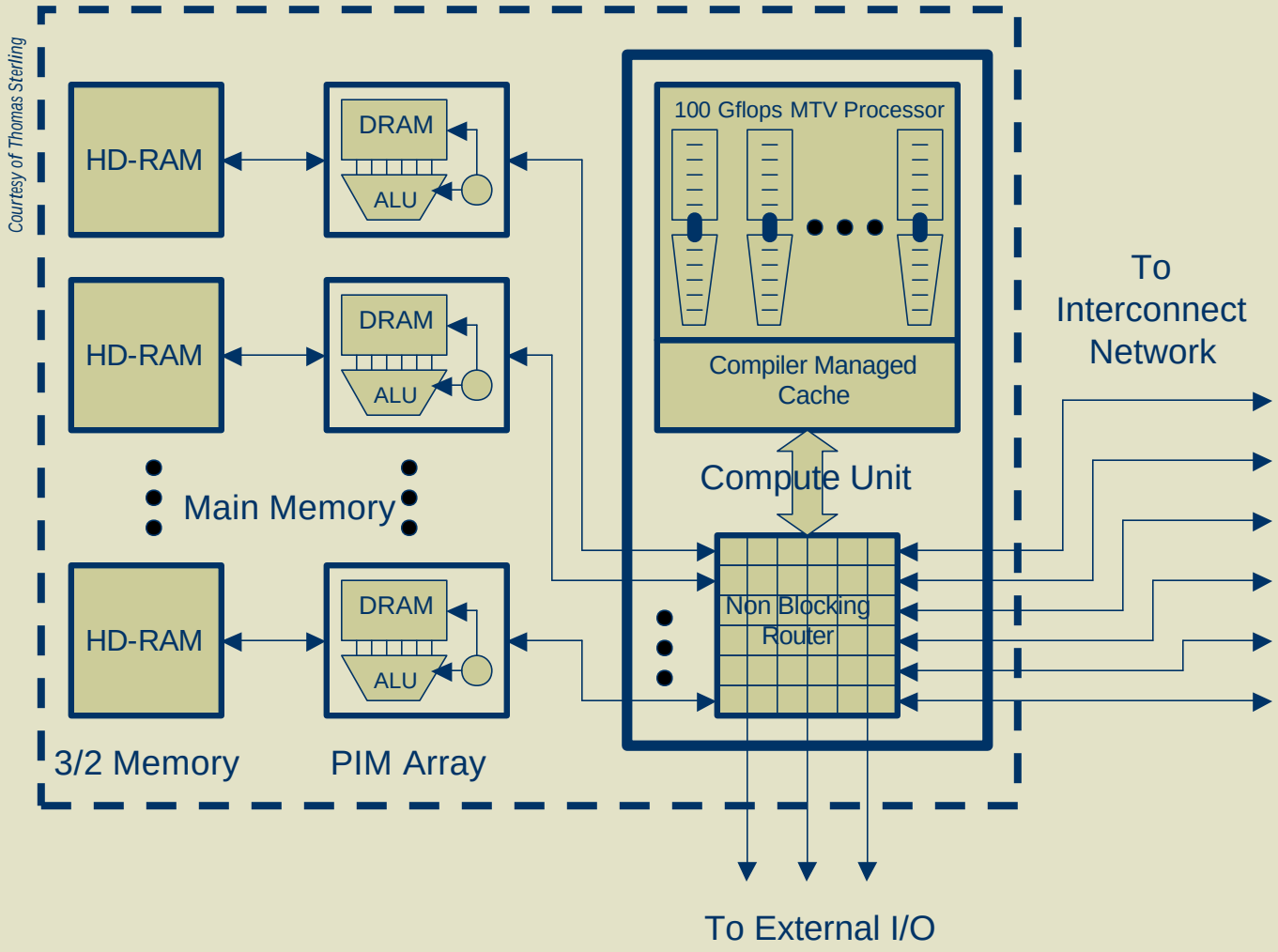
Earth Simulator



Architectures



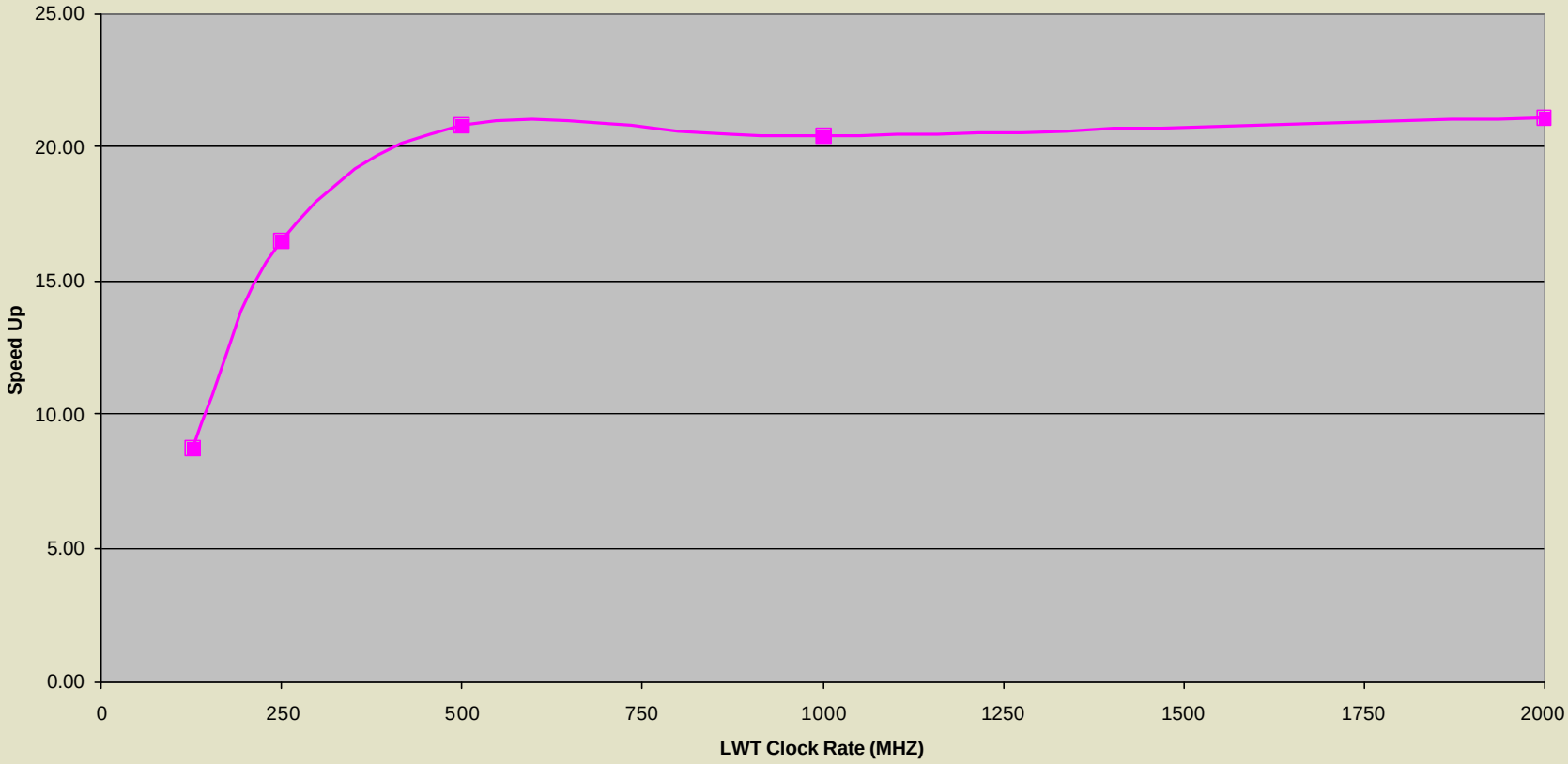
Cascade Node



Roles for PIM/MIND in *Cascade*

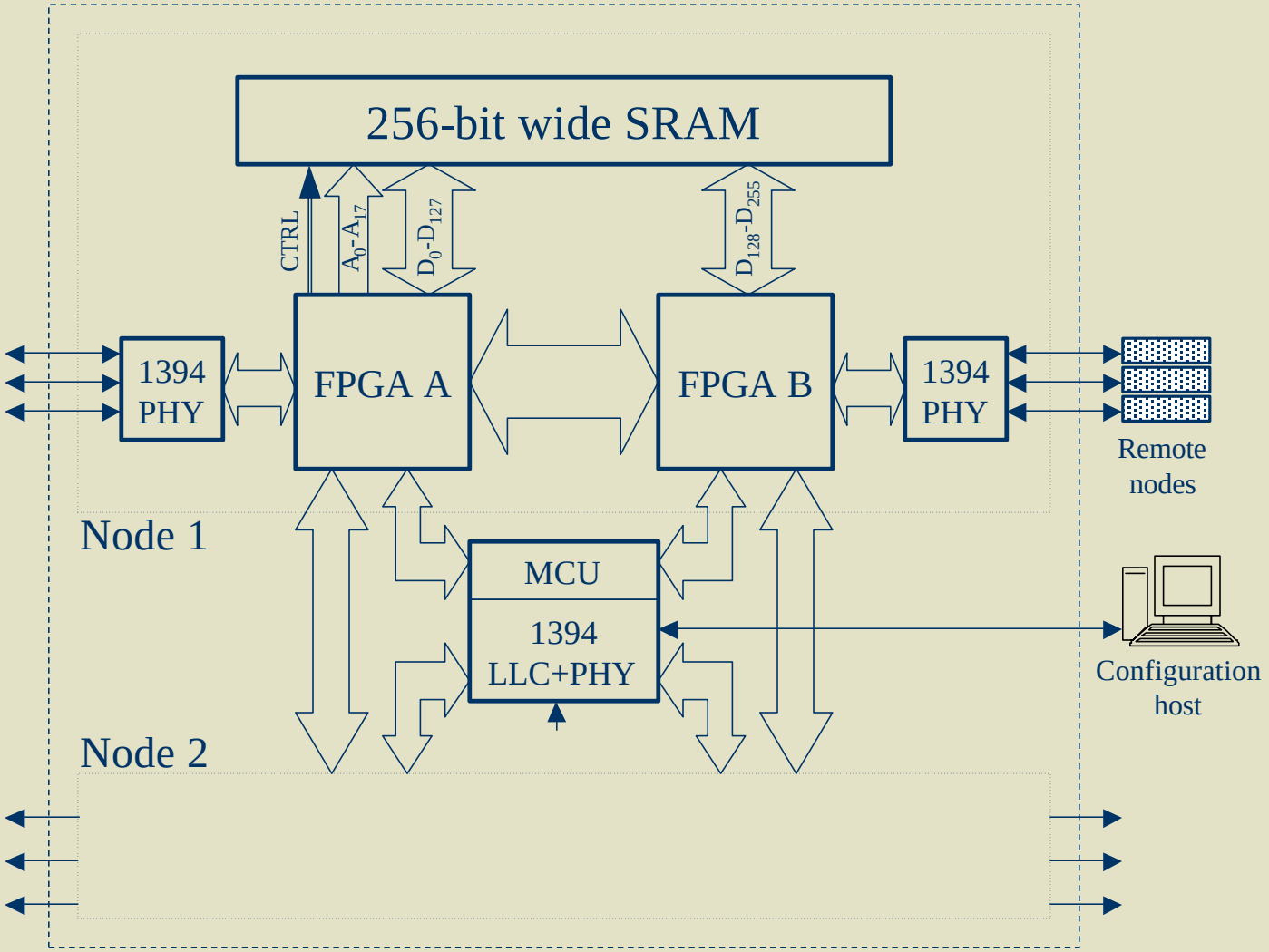
- Perform in-place operations on zero-reuse data
- Exploit high degree data parallelism
- Rapid updates on contiguous data blocks
- Rapid associative searches through contiguous data blocks
- Gather-scatters
- Tree/graph walking
- Enables efficient and concurrent array transpose
- Permits fine grain manipulation of sparse and irregular data structures
- Parallel prefix operations
- In-memory data movement
- Memory management overhead work
- Engage in prestaging of data for MTV/HWT processors
- Fault monitoring, detection, and cleanup
- Manage 3/2 memory layer

Speedup Smart Memory Over Dumb Memory for Various LWT Clock Rates
64 Smart Memory Nodes



FPGA-based Breadboard

- FPGA technology has reached million gate count
- Rapid prototyping enabled
- MIND breadboard
  - Dual node MIND module
  - Each node
    - 2 FPGAs
    - 8 Mbytes of SRAM
    - External serial interconnect for parcels
    - Interface to other on-board node
- Test Facility
  - Rack of four cages
  - Each cage with eight MIND modules
- Alpha boards near completion (4)
- Beta board design waiting next generation parts


256-bit wide SRAM
CTRL
A0-A17
D0-D127
D128-D255
1394 PHY
FPGA A
FPGA B
1394 PHY
Remote nodes
Node 1
MCU
1394 LLC+PHY
Configuration host
Node 2

MIND Prototype